



IQS7222C OVERVIEW

10 Channel Mutual / 8 Channel Self- Capacitive Touch and Proximity Controller with I²C communications interface, configurable GPIOs and low power options

1 Device Overview

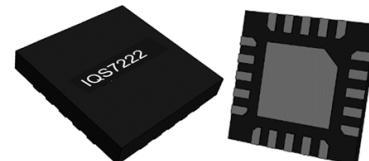
The IQS7222C ProxFusion® IC is a sensor fusion device for various multi-button applications. The sensor is fully I²C compatible and on-chip calculations enable the IC to respond effectively even in lowest power modes.

1.1 Main Features

- > Highly flexible ProxFusion® device
- > 9 (QFN) / 8 (WLCSP) external sensor pad connections
- > Configure up to 10 Channels using the external connections or internal sensorⁱ
- > External sensor options:
 - Up to 8 self capacitive buttons
 - Up to 4 self capacitive wear detection pairs (with physical reference)
 - Up to 10 projected capacitive touch/proximity sensors
 - Up to 4 inductive sensor elements
- > Built-in basic functions:
 - Automatic tuning
 - Noise filtering
 - Differential measurements (reference channels)
 - Debounce & Hysteresis
 - Dual direction trigger indication
- > Built-in Signal processing options:
 - Slider output
 - Wheel output
- > Design simplicity
 - PC Software for debugging and obtaining optimal settings and performance
 - One-time programmable settings for custom power-on IC configuration
 - Auto-run from programmed settings for simplified integration
- > Automated system power modes for optimal response vs consumption
- > I²C communication interface with IRQ/RDY(up to fast plus -1MHz)
- > Event and streaming modes
- > Customizable user interface due to programmable memory
- > Supply Voltage 1.8V(-5%)to 3.5V
- > Small packages
 - WLCSP18 (1.62 x 1.62 x 0.5 mm) - interleaved 0.4mm x 0.6mm ball pitch
 - QFN20 (3 x 3 x 0.5 mm) - 0.4mm pitch



WLCSP18 & QFN20 package
Representation only



1.2 Applications

- > SAR Compliance in Mobile devices
- > Wear Detection
- > Appliance user interface (Sliders, Wheels & Buttons)
- > Waterproof Buttons (Inductive)
- > Low power Wake-up Buttons / Proximity

ⁱWLCSP18 package has 1 less external pad connection and the maximum amount of buttons that can be configured are less than QFN20 packgae



1.3 Block Diagram

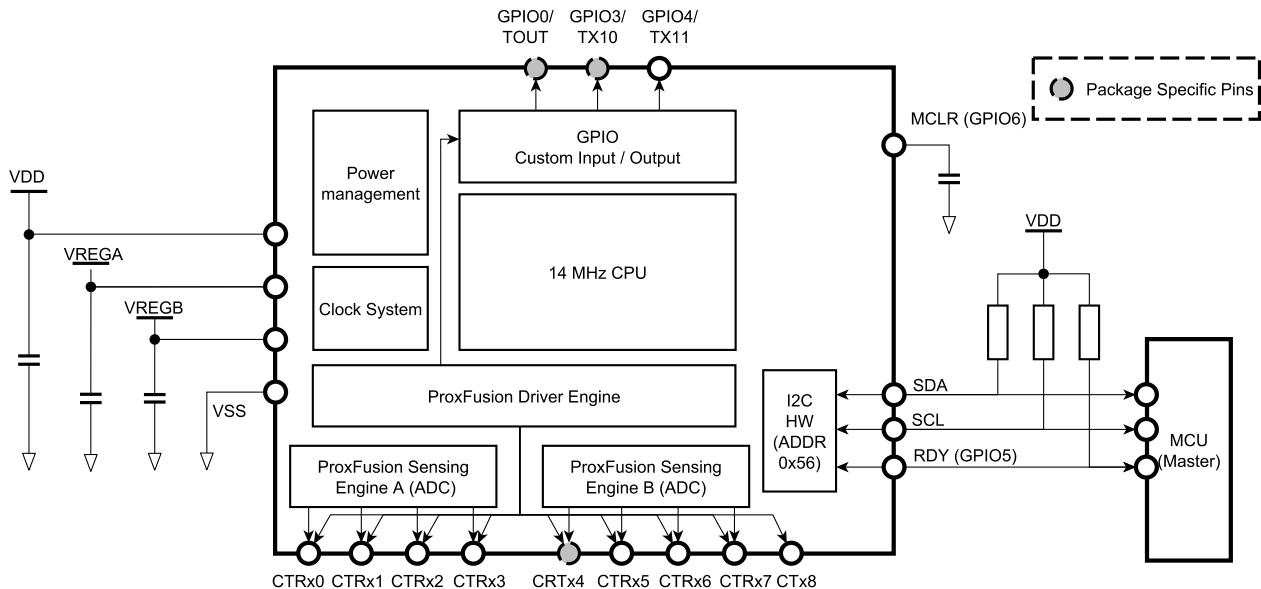


Figure 1.1: Functional Block Diagramⁱ

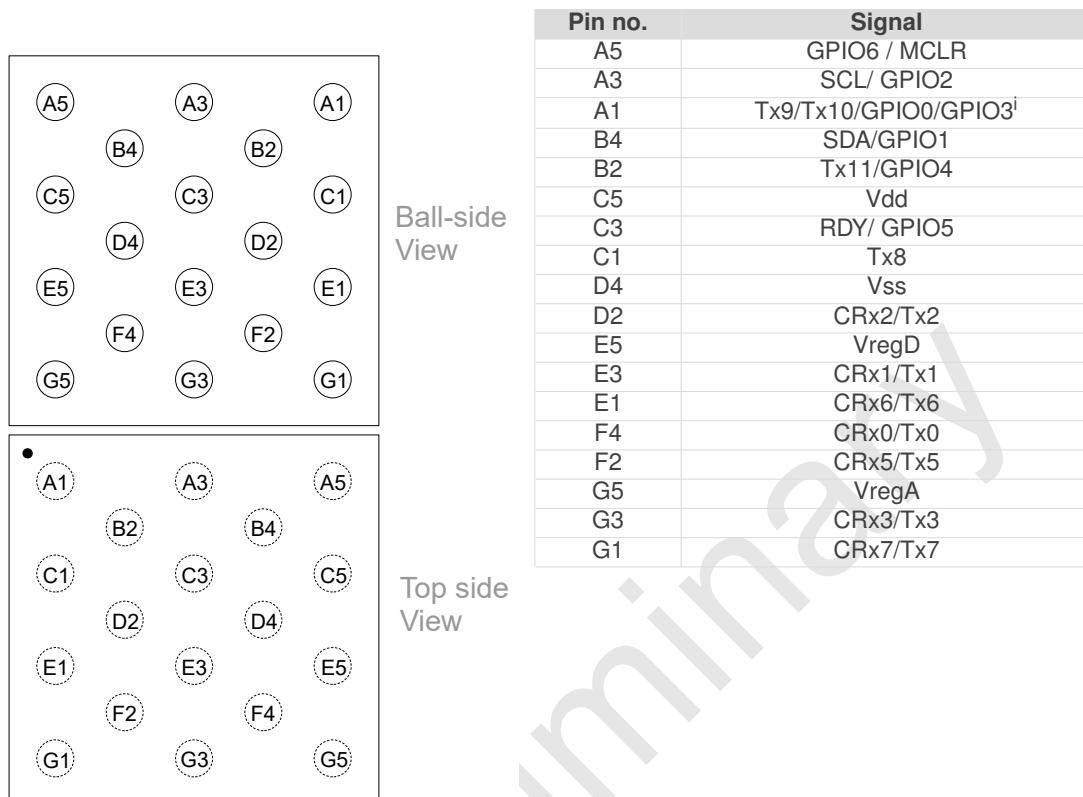
ⁱWLCSP18 packages do not have a CRx4 and combines GPIO0 and GPIO3



2 Hardware Connection

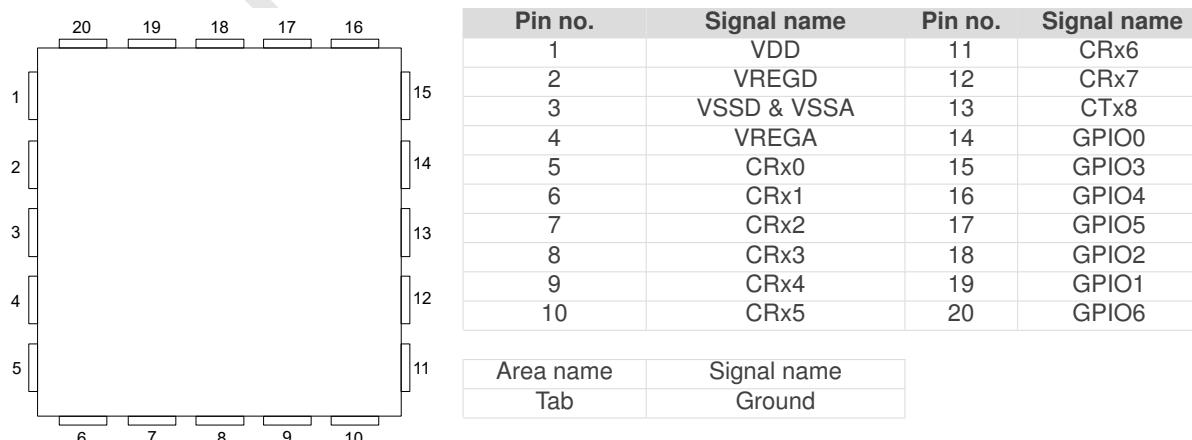
2.1 WLCSP18 Pin Diagrams

Table 2.1: 18-pin WLCSP18 Package (Bottom/Ball-side View)



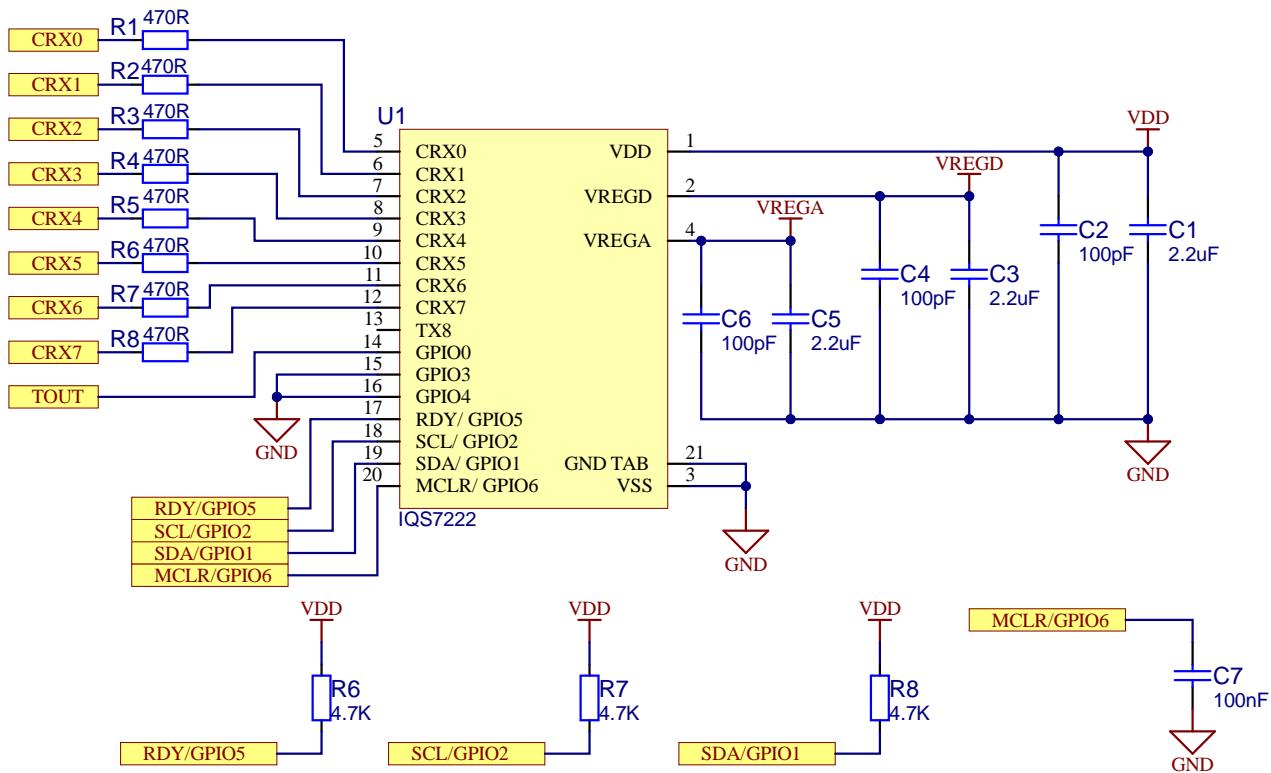
2.2 QFN20 Pin Diagram

Table 2.2: 20-pin QFN Package (Top View)

ⁱPlease note that Tx9 and Tx10 are shorted in the WLCSP18 package



2.3 Reference Schematic



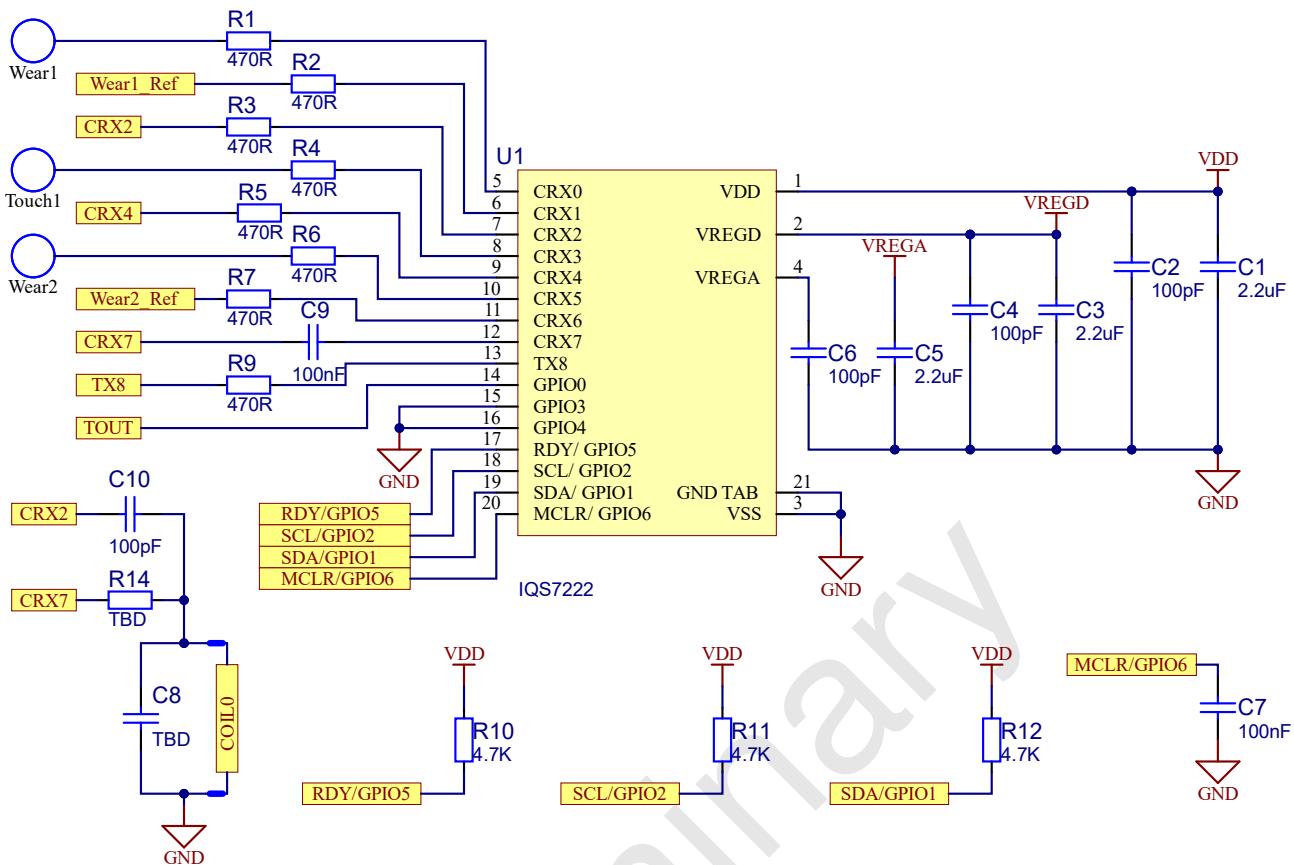


Figure 2.2: Wear, Reference and Inductive Sensing Reference Schematic

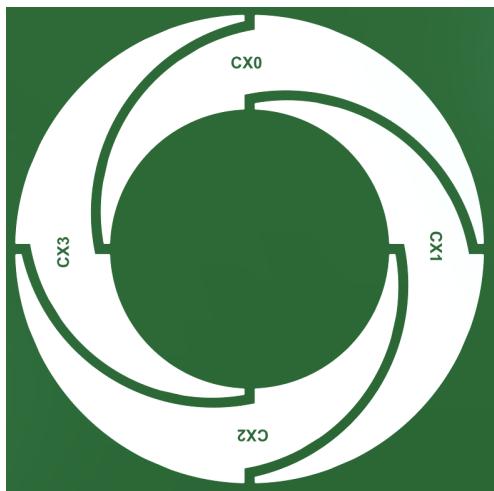
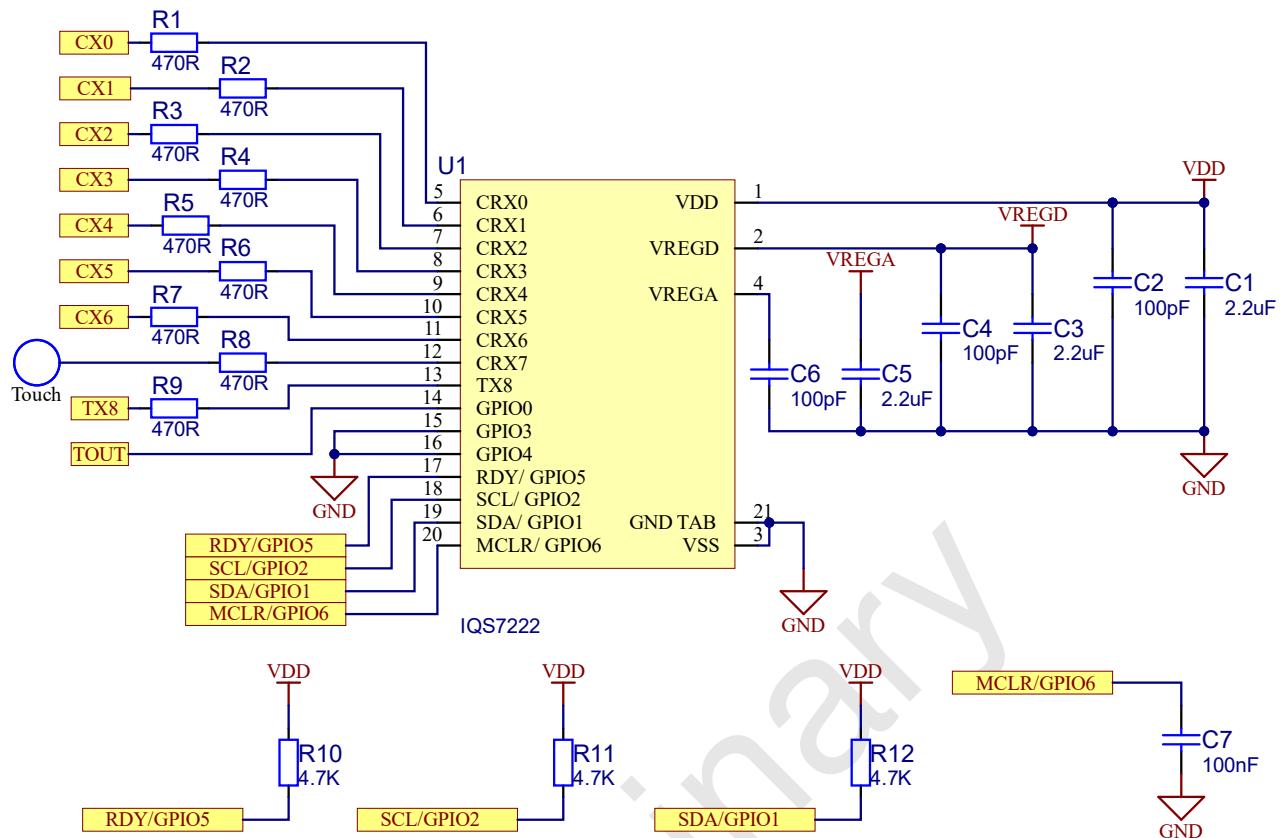


Figure 2.3: 3 Channel Slider, 4 Channel Wheel with Touch Sensor Reference Schematic



3 Electrical Characteristics

3.1 Absolute Maximum Ratings

Table 3.1: Absolute Maximum Ratings

	Min	Max	Unit
Voltage applied at VDD pin to VSS	1.71	3.5	V
Voltage applied to any ProxFusion® pin	-0.3	VREG	V
Voltage applied to any other pin (referenced to VSS)	-0.3	VDD + 0.3 (3.5V max)	V
Storage temperature, T _{stg}	-40	85	°C

3.2 ESD Rating

Table 3.2: ESD Rating

		Value	Unit
V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁱ	± 4000	V

3.3 Recommended Operating Conditions

Table 3.3: Recommended Operating Conditions

Recommended operating conditions	Min	Nom	Max	Unit
VDD Supply voltage applied at VDD pin	1.71		3.5	V
VregA Internal regulated supply output for analog domain	1.5	1.53	1.75	V
VregD Internal regulated supply output for digital domain	1.57	1.59	1.8 ⁱⁱ	V
VSS Supply voltage applied at VSS pin	0	0	0	V
T _A Operating free-air temperature	-40	25	85	°C
C _{VDD} Recommended capacitor at VDD	1	2	10	μF
C _{VREGA} Recommended external buffer capacitor at VREG, ESR≤ 200mΩ	1	2	10	μF
C _{VREGD} Recommended external buffer capacitor at VREG, ESR≤ 200mΩ	1	2	10	μF
C _{x_SELF-VSS} Maximum capacitance of all external electrodes on all ProxFusion® blocks (self-capacitance mode)	-	-	400	pF
C _{m_CTX-CRX} Capacitance of all external electrodes on all ProxFusion® blocks (mutual-cap mode)	0.1	-	90	pF
C _{x_CRX-VSS-1M} Maximum capacitance of all external electrodes on all ProxFusion® blocks (mutual-capacitance mode @f _{xfer} =1MHz)			100	pF
C _{x_CRX-VSS-4M} Maximum capacitance of all external electrodes on all ProxFusion® blocks (mutual-capacitance mode @ f _{xfer} =4MHz sensing))			25	pF
$\frac{C_{x_{CRX-VSS}}}{C_{m_{CTX-CRX}}}$ Capacitance ratio for optimal SNR in mutual capacitance mode	10		20	n/a
RC _{x_CRX/CTX} Series (in-line) resistance of all mutual capacitance pins (Tx & Rx pins) in mutual capacitance mode	0 ⁱⁱⁱ	0.47	10 ^{iv}	kΩ
RC _{x_SELF} Series (in-line) resistance of all self capacitance pins in self capacitance mode	0 ⁱⁱ	0.47	10 ^{iv}	kΩ

ⁱ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±4000 V may actually have higher performance.

ⁱⁱVdd≥2V

ⁱⁱⁱNominal series resistance of 470Ω is recommended to prevent received and emitted EMI effects. Typical resistance also adds additional ESD protection

^{iv}Series resistance limit is a function of f_{xfer} and the circuit time constant, RC. R_{max} × C_{max} = $\frac{1}{(6 \times f_{xfer})}$ where "C" is the pin capacitance to Vss.



3.4 Current Consumption

Mutual Inductive Mode Setup: Target: 50, FOSC = 18MHZ, Clock Divider = 0

Self-capacitive Mode Setup: Target = 512, Fxfer = 500kHz

Interface Selection: Event mode

Power mode	Active channels	Report rate (Sampling rate) [ms]	Typical Current [μ A]
Active Mode	Mutual Inductive (2 coils)	10	156
	Self-capacitive (8 channels)	10	610
Idle	Self-capacitive (8 channels)	50	120
	Mutual Inductive (2 coils)	80	20
ULP	Wake-up proximity - Distributed self channel	160	9
	Mutual Inductive (2 coils)	200	10



4 Ordering Information

IQS7222C zzz ppb

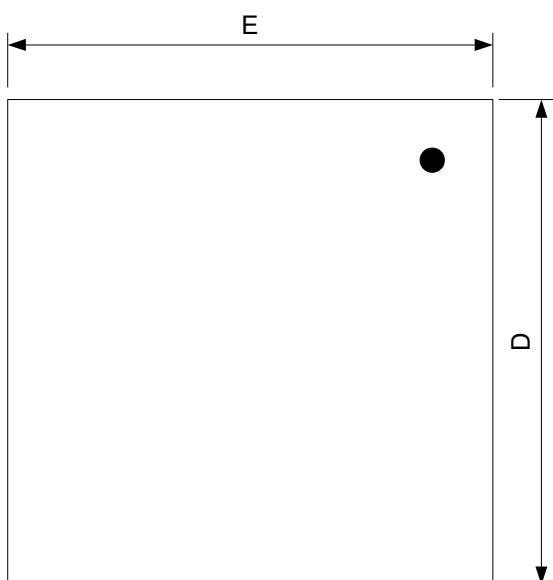
IC NAME	IQS7222C	=	IQS7222C	
POWER-ON CONFIGURATION	zzz	=	001	8 button self capacitance startup, configurable via I ² C
PACKAGE TYPE	pp	=	CS	WLCSP-18 package
BULK PACKAGING	b	=	QN	QFN-20 package
			R	WLCSP-18 Reel (3000pcs/reel)
				QFN-20 Reel (2000pcs/reel)

Figure 4.1: Order Code Description

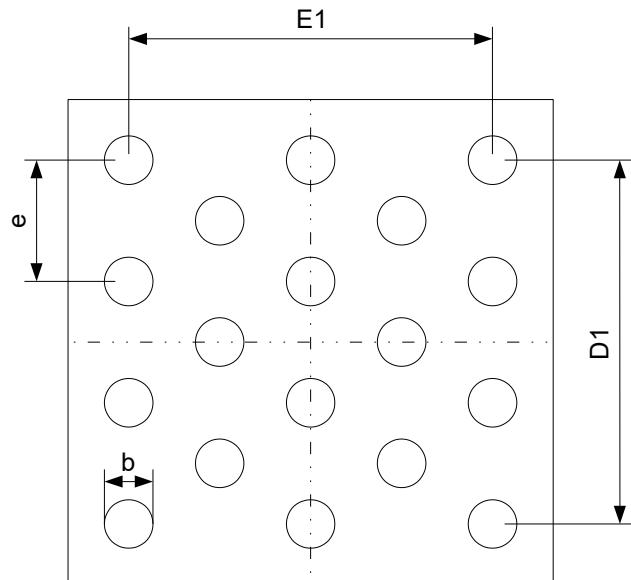
Preliminary

5 Package Specification

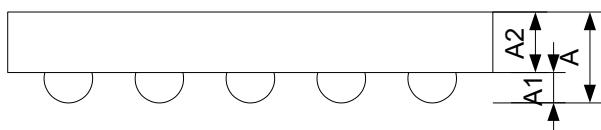
5.1 Package Outline Description - WLCSP18



Top View



Bottom (Ball Side) View



Side View

Figure 5.1: WLCSP (1.62x1.62) - 18 Package Outline Visual Description

Table 5.1: WLCSP (1.62x1.62) - 18 Package Outline Visual Description

Dimension	[mm]	Dimension	[mm]
A	0.525 ± 0.05	D1	1.2
A1	0.2 ± 0.02	E	1.620 ± 0.015
A2	0.3 ± 0.025	E1	1.2
b	0.260 ± 0.39	e	0.4
D	1.620 ± 0.015		

5.2 Package Outline Description - QFN20

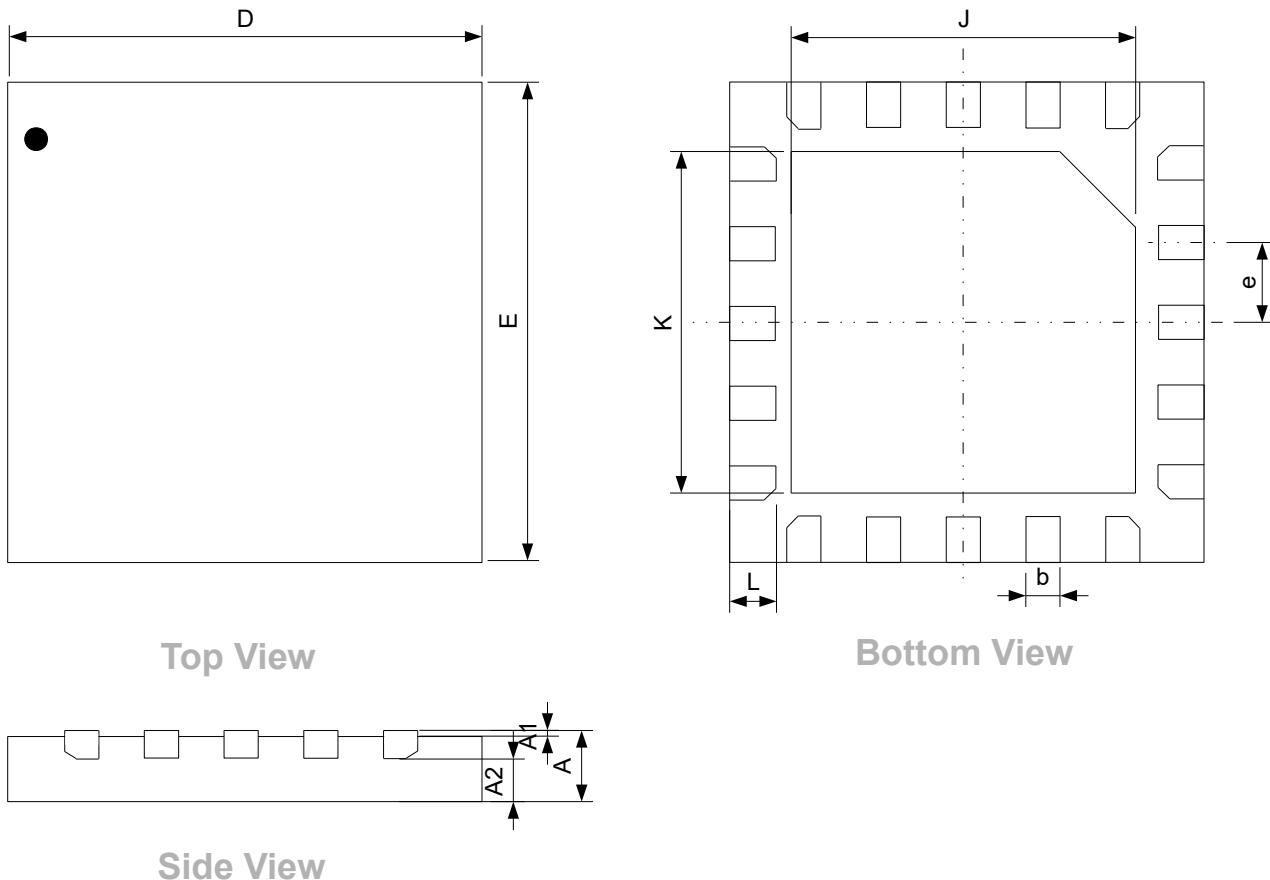


Figure 5.2: QFN (3x3)-20 Package Outline Visual Description

Table 5.2: QFN (3x3)-20 Package Outline Visual Description

Dimension	[mm]	Dimension	[mm]
A	0.5±0.1	E	3
A1	0.035±0.05	e	0.4
A2	0.3	J	1.7±0.1
A3	0.203	K	1.7±0.1
b	0.2±0.05	L	0.4±0.05
D	3		



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